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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	F ² MC-16FX
Core Size	16-Bit
Speed	56MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, UART/USART
Peripherals	DMA, LVD, LVR, POR, PWM, WDT
Number of I/O	49
Program Memory Size	288KB (288K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	12K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 15x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb96f356rwbpmc1-gse2

MB96350 Series

■ FEATURES

Feature	Description
Technology	• 0.18μm CMOS
CPU	• F²MC-16FX CPU • Up to 56 MHz internal, 17.8 ns instruction cycle time • Optimized instruction set for controller applications (bit, byte, word and long-word data types; 23 different addressing modes; barrel shift; variety of pointers) • 8-byte instruction execution queue • Signed multiply (16-bit × 16-bit) and divide (32-bit/16-bit) instructions available
System clock	• On-chip PLL clock multiplier (x1 - x25, x1 when PLL stop) • 3 MHz - 16 MHz external crystal oscillator clock (maximum frequency when using ceramic resonator depends on Q-factor). • Up to 56 MHz external clock • 32-100 kHz subsystem quartz clock • 100kHz/2MHz internal RC clock for quick and safe startup, oscillator stop detection, watchdog • Clock source selectable from main- and subclock oscillator (part number suffix "W") and on-chip RC oscillator, independently for CPU and 2 clock domains of peripherals. • Low Power Consumption - 13 operating modes : (different Run, Sleep, Timer modes, Stop mode) • Clock modulator
On-chip voltage regulator	• Internal voltage regulator supports reduced internal MCU voltage, offering low EMI and low power consumption figures
Low voltage reset	• Reset is generated when supply voltage is below minimum.
Code Security	• Protects ROM content from unintended read-out
Memory Patch Function	• Replaces ROM content • Can also be used to implement embedded debug support
DMA	• Automatic transfer function independent of CPU, can be assigned freely to resources
Interrupts	• Fast Interrupt processing • 8 programmable priority levels • Non-Maskable Interrupt (NMI)
Timers	• Three independent clock timers (23-bit RC clock timer, 23-bit Main clock timer, 17-bit Sub clock timer) • Watchdog Timer

MB96350 Series

Feature	Description
Real Time Clock	• Can be clocked either from sub oscillator (devices with part number suffix “W”), main oscillator or from the RC oscillator • Facility to correct oscillation deviation of Sub clock or RC oscillator clock (clock calibration) • Read/write accessible second/minute/hour registers • Can signal interrupts every half second/second/minute/hour/day • Internal clock divider and prescaler provide exact 1s clock
External Interrupts	• Edge sensitive or level sensitive • Interrupt mask and pending bit per channel • Each available CAN channel RX has an external interrupt for wake-up • Selected USART channels SIN have an external interrupt for wake-up
Non Maskable Interrupt	• Disabled after reset • Once enabled, can not be disabled other than by reset. • Level high or level low sensitive • Pin shared with external interrupt 0.
External bus interface	• 8-bit or 16-bit bidirectional data • Up to 24-bit addresses • 6 chip select signals • Multiplexed address/data lines • Wait state request • External bus master possible • Timing programmable
I/O Ports	• Virtually all external pins can be used as general purpose I/O • All push-pull outputs (except when used as I2C SDA/SCL line) • Bit-wise programmable as input/output or peripheral signal • Bit-wise programmable input enable • Bit-wise programmable input levels: Automotive / CMOS-Schmitt trigger / TTL • Bit-wise programmable pull-up resistor • Bit-wise programmable output driving strength for EMI optimization
Packages	• 64-pin plastic LQFP M23/M24

MB96350 Series

Feature	Description
Flash Memory	• Supports automatic programming, Embedded Algorithm • Write/Erase/Erase-Suspend/Resume commands • A flag indicating completion of the algorithm • Number of erase cycles: 10,000 times • Data retention time: 20 years • Erase can be performed on each sector individually • Sector protection • Flash Security feature to protect the content of the Flash • Low voltage detection during Flash erase

MB96350 Series

■ PRODUCT LINEUP

Features		MB96V300B	MB96(F)35x
Product type		Evaluation sample	Flash product: MB96F35x Mask ROM product: MB9635x
Product options			
YS		NA	Low voltage reset persistently on / Single clock devices
RS			Low voltage reset can be disabled / Single clock devices
YW			Low voltage reset persistently on / Dual clock devices
RW			Low voltage reset can be disabled / Dual clock devices
AS			No CAN / Low voltage reset can be disabled / Single clock devices
AW			No CAN / Low voltage reset can be disabled / Dual clock devices
Flash/ ROM	RAM		
96KB	8KB	ROM/Flash memory emulation by external RAM, 92KB internal RAM	MB96F353R, MB96F353A *1
160KB	8KB		MB96F355R, MB96F355A *1
288KB	12KB		MB96F356Y, MB96F356R, MB96F356A
Package		BGA416	FPT-64P-M23/24
DMA		16 channels	4 channels
USART		10 channels	4 channels
I2C		2 channels	1 channel
A/D Converter		40 channels	15 channels
A/D Converter Reference Voltage switch		yes	No
16-bit Reload Timer		6 channels + 1 channel (for PPG)	4 channels + 1 channel (for PPG)
16-bit Free-Running Timer		4 channels	4 channels (2 channels with external clock input pin)
16-bit Output Compare		12 channels	4 channels
16-bit Input Capture		12 channels	6 channels (plus 2 channels for LIN USART)
16-bit Programmable Pulse Generator		20 channels	20 channels
CAN Interface		5 channels	MB96F35xA: no MB96F353R/F355R: 1 channel MB96F356Y/R: 2 channels
External Interrupts		16 channels	13 channels
Non-Maskable Interrupt		1 channel	

MB96350 Series

■ MEMORY MAP

	MB96V300B		MB96(F)35x	
FF:FFF _H	Emulation ROM		USER ROM / External Bus ^{*4}	
DE:000 _H	External Bus		External Bus	
10:000 _H	Boot-ROM		Boot-ROM	
0F:E00 _H	Reserved		Reserved	
0E:000 _H	External RAM		Reserved	
02:000 _H	Internal RAM bank 1	RAMEND1 ^{*2} RAMSTART1 ^{*2}	Reserved Internal RAM bank 1 Reserved	RAM availability de- pending on the device
01:000 _H	ROM/RAM MIRROR		ROM/RAM MIRROR	
00:800 _H	Internal RAM bank 0	RAMSTART0 ^{*2}	Internal RAM bank 0 Reserved	External Bus end address ^{*2}
RAMSTART0 ^{*3}	External Bus		External Bus	
00:0C0 _H	Peripherals		Peripherals	
00:0380 _H	GPR ^{*1}		GPR ^{*1}	
00:0180 _H	DMA		DMA	
00:0100 _H	External Bus		External Bus	
00:00F0 _H	Peripheral		Peripheral	
00:000 _H				

*1: Unused GPR banks can be used as RAM area

*2: For External Bus end address and RAMSTART/END addresses, please refer to the table on the next page.

*3: For EVA device, RAMSTART0 depends on the configuration of the emulated device.

*4: For details about USER ROM area, see the ■ USER ROM MEMORY MAP FOR FLASH DEVICES on the following pages.

The External Bus area and DMA area are only available if the device contains the corresponding resource.

The available RAM and ROM area depends on the device.

MB96350 Series

■ I/O MAP

I/O map MB96(F)35x (1 of 28)

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
000000 _H	I/O Port P00 - Port Data Register	PDR00		R/W
000001 _H	I/O Port P01 - Port Data Register	PDR01		R/W
000002 _H	I/O Port P02 - Port Data Register	PDR02		R/W
000003 _H	I/O Port P03 - Port Data Register	PDR03		R/W
000004 _H	I/O Port P04 - Port Data Register	PDR04		R/W
000005 _H	I/O Port P05 - Port Data Register	PDR05		R/W
000006 _H	I/O Port P06 - Port Data Register	PDR06		R/W
000007 _H - 000017 _H	Reserved			-
000018 _H	ADC0 - Control Status register Low	ADCSL	ADCS	R/W
000019 _H	ADC0 - Control Status register High	ADCSH		R/W
00001A _H	ADC0 - Data Register Low	ADCRL	ADCR	R
00001B _H	ADC0 - Data Register High	ADCRH		R
00001C _H	ADC0 - Setting Register		ADSR	R/W
00001D _H	ADC0 - Setting Register			R/W
00001E _H	ADC0 - Extended Configuration Register	ADECR		R/W
00001F _H	Reserved			-
000020 _H	FRT0 - Data register of free-running timer		TCDT0	R/W
000021 _H	FRT0 - Data register of free-running timer			R/W
000022 _H	FRT0 - Control status register of free-running timer Low	TCCSL0	TCCS0	R/W
000023 _H	FRT0 - Control status register of free-running timer High	TCCSH0		R/W
000024 _H	FRT1 - Data register of free-running timer		TCDT1	R/W
000025 _H	FRT1 - Data register of free-running timer			R/W
000026 _H	FRT1 - Control status register of free-running timer Low	TCCSL1	TCCS1	R/W
000027 _H	FRT1 - Control status register of free-running timer High	TCCSH1		R/W
000028 _H - 000033 _H	Reserved			-

MB96350 Series

I/O map MB96(F)35x (7 of 28)

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
0000DA _H	USART2 - Baud Rate Generator Register Low	BGRL2	BGR2	R/W
0000DB _H	USART2 - Baud Rate Generator Register High	BGRH2		R/W
0000DC _H	USART2 - Extended Serial Interrupt Register	ESIR2		R/W
0000DD _H	Reserved			-
0000DE _H	USART3 - Serial Mode Register	SMR3		R/W
0000DF _H	USART3 - Serial Control Register	SCR3		R/W
0000E0 _H	USART3 - TX Register	TDR3		W
0000E0 _H	USART3 - RX Register	RDR3		R
0000E1 _H	USART3 - Serial Status	SSR3		R/W
0000E2 _H	USART3 - Control/Com. Register	ECCR3		R/W
0000E3 _H	USART3 - Ext. Status Register	ESCR3		R/W
0000E4 _H	USART3 - Baud Rate Generator Register Low	BGRL3	BGR3	R/W
0000E5 _H	USART3 - Baud Rate Generator Register High	BGRH3		R/W
0000E6 _H	USART3 - Extended Serial Interrupt Register	ESIR3		R/W
0000E7 _H ~ 0000EF _H	Reserved			-
0000F0 _H ~ 0000FF _H	External Bus area	EXTBUS0		R/W
000100 _H	DMA0 - Buffer address pointer low byte	BAPL0		R/W
000101 _H	DMA0 - Buffer address pointer middle byte	BAPM0		R/W
000102 _H	DMA0 - Buffer address pointer high byte	BAPH0		R/W
000103 _H	DMA0 - DMA control register	DMACS0		R/W
000104 _H	DMA0 - I/O register address pointer low byte	IOAL0	IOA0	R/W
000105 _H	DMA0 - I/O register address pointer high byte	IOAH0		R/W
000106 _H	DMA0 - Data counter low byte	DCTL0	DCT0	R/W
000107 _H	DMA0 - Data counter high byte	DCTH0		R/W
000108 _H	DMA1 - Buffer address pointer low byte	BAPL1		R/W
000109 _H	DMA1 - Buffer address pointer middle byte	BAPM1		R/W
00010A _H	DMA1 - Buffer address pointer high byte	BAPH1		R/W
00010B _H	DMA1 - DMA control register	DMACS1		R/W
00010C _H	DMA1 - I/O register address pointer low byte	IOAL1	IOA1	R/W

MB96350 Series

I/O map MB96(F)35x (11 of 28)

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
0003DB _H	Memory Patch function - Patch data 5 High	PFDH5		R/W
0003DC _H	Memory Patch function - Patch data 6 Low	PFDL6	PFD6	R/W
0003DD _H	Memory Patch function - Patch data 6 High	PFDH6		R/W
0003DE _H	Memory Patch function - Patch data 7 Low	PFDL7	PFD7	R/W
0003DF _H	Memory Patch function - Patch data 7 High	PFDH7		R/W
0003E0 _H - 0003F0 _H	Reserved			-
0003F1 _H	Memory Control Status Register A	MCSRA		R/W
0003F2 _H	Memory Timing Configuration Register A Low	MTCRAL	MTCRA	R/W
0003F3 _H	Memory Timing Configuration Register A High	MTCRAH		R/W
0003F4 _H - 0003F8 _H	Reserved			-
0003F9 _H	Flash Memory Write Control register 1	FMWC1		R/W
0003FA _H	Flash Memory Write Control register 2	FMWC2		R/W
0003FB _H	Flash Memory Write Control register 3	FMWC3		R/W
0003FC _H	Flash Memory Write Control register 4	FMWC4		R/W
0003FD _H	Flash Memory Write Control register 5	FMWC5		R/W
0003FE _H - 0003FF _H	Reserved			-
000400 _H	Standby Mode control register	SMCR		R/W
000401 _H	Clock select register	CKSR		R/W
000402 _H	Clock Stabilisation select register	CKSSR		R/W
000403 _H	Clock monitor register	CKMR		R
000404 _H	Clock Frequency control register Low	CKFCRL	CKFCR	R/W
000405 _H	Clock Frequency control register High	CKFCRH		R/W
000406 _H	PLL Control register Low	PLLCRL	PLLCR	R/W
000407 _H	PLL Control register High	PLLCRH		R/W
000408 _H	RC clock timer control register	RCTCR		R/W
000409 _H	Main clock timer control register	MCTCR		R/W
00040A _H	Sub clock timer control register	SCTCR		R/W

MB96350 Series

I/O map MB96(F)35x (15 of 28)

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
0004DA _H	Peripheral Resource Relocation Register 4	PRRR4		R/W
0004DB _H	Peripheral Resource Relocation Register 5	PRRR5		R/W
0004DC _H	Peripheral Resource Relocation Register 6	PRRR6		R/W
0004DD _H	Peripheral Resource Relocation Register 7	PRRR7		R/W
0004DE _H	Peripheral Resource Relocation Register 8	PRRR8		R/W
0004DF _H	Peripheral Resource Relocation Register 9	PRRR9		R/W
0004E0 _H	RTC - Sub Second Register L	WTBRL0	WTBR0	R/W
0004E1 _H	RTC - Sub Second Register M	WTBRH0		R/W
0004E2 _H	RTC - Sub-Second Register H	WTBR1		R/W
0004E3 _H	RTC - Second Register	WTSR		R/W
0004E4 _H	RTC - Minutes	WTMR		R/W
0004E5 _H	RTC - Hour	WTHR		R/W
0004E6 _H	RTC - Timer Control Extended Register	WTCER		R/W
0004E7 _H	RTC - Clock select register	WTCKSR		R/W
0004E8 _H	RTC - Timer Control Register Low	WTCRL	WTCR	R/W
0004E9 _H	RTC - Timer Control Register High	WTCRH		R/W
0004EA _H	CAL - Calibration unit Control register	CUCR		R/W
0004EB _H	Reserved			-
0004EC _H	CAL - Duration Timer Data Register Low	CUTDL	CUTD	R/W
0004ED _H	CAL - Duration Timer Data Register High	CUTDH		R/W
0004EE _H	CAL - Calibration Timer Register 2 Low	CUTR2L	CUTR2	R
0004EF _H	CAL - Calibration Timer Register 2 High	CUTR2H		R
0004F0 _H	CAL - Calibration Timer Register 1 Low	CUTR1L	CUTR1	R
0004F1 _H	CAL - Calibration Timer Register 1 High	CUTR1H		R
0004F2 _H - 0004F9 _H	Reserved			-
0004FA _H	RLT - Timer input select (for Cascading)	TMISR		R/W
0004FB _H - 0004FF _H	Reserved			-
000500 _H	FRT2 - Data register of free-running timer		TCDT2	R/W
000501 _H	FRT2 - Data register of free-running timer			R/W

MB96350 Series

I/O map MB96(F)35x (17 of 28)

Address	Register	Abbreviation 8-bit access	Abbreviation 16-bit access	Access
000543 _H	USART7 - Ext. Status Com. Register	ESCR7		R/W
000544 _H	USART7 - Baud Rate Generator Register Low	BGRL7	BGR7	R/W
000545 _H	USART7 - Baud Rate Generator Register High	BGRH7		R/W
000546 _H	USART7 - Extended Serial Interrupt Register	ESIR7		R/W
000547 _H	Reserved			-
000548 _H	USART8 - Serial Mode Register	SMR8		R/W
000549 _H	USART8 - Serial Control Register	SCR8		R/W
00054A _H	USART8 - Serial TX Register	TDR8		W
00054A _H	USART8 - Serial RX Register	RDR8		R
00054B _H	USART8 - Serial Status Register	SSR8		R/W
00054C _H	USART8 - Ext. Control/Com. Register	ECCR8		R/W
00054D _H	USART8 - Ext. Status Com. Register	ESCR8		R/W
00054E _H	USART8 - Baud Rate Generator Register Low	BGRL8	BGR8	R/W
00054F _H	USART8 - Baud Rate Generator Register High	BGRH8		R/W
000550 _H	USART8 - Extended Serial Interrupt Register	ESIR8		R/W
000551 _H - 000563 _H	Reserved			-
000564 _H	PPG6 - Timer register		PTMR6	R
000565 _H	PPG6 - Timer register			R
000566 _H	PPG6 - Period setting register		PCSR6	W
000567 _H	PPG6 - Period setting register			W
000568 _H	PPG6 - Duty cycle register		PDUT6	W
000569 _H	PPG6 - Duty cycle register			W
00056A _H	PPG6 - Control status register Low	PCNL6	PCN6	R/W
00056B _H	PPG6 - Control status register High	PCNH6		R/W
00056C _H	PPG7 - Timer register		PTMR7	R
00056D _H	PPG7 - Timer register			R
00056E _H	PPG7 - Period setting register		PCSR7	W
00056F _H	PPG7 - Period setting register			W
000570 _H	PPG7 - Duty cycle register		PDUT7	W

MB96350 Series

Interrupt vector table MB96(F)35x (2 of 3)

Vector number	Offset in vector table	Vector name	Cleared by DMA	Index in ICR to program	Description
33	378 _H	CAN2	No	33	CAN Controller 2 (only MB96F356Y/R and MB96F353R/F355R)
34	374 _H	PPG0	Yes	34	Programmable Pulse Generator 0
35	370 _H	PPG1	Yes	35	Programmable Pulse Generator 1
36	36C _H	PPG2	Yes	36	Programmable Pulse Generator 2
37	368 _H	PPG3	Yes	37	Programmable Pulse Generator 3
38	364 _H	PPG4	Yes	38	Programmable Pulse Generator 4
39	360	PPG5	Yes	39	Programmable Pulse Generator 5
40	35C _H	PPG6	Yes	40	Programmable Pulse Generator 6
41	358 _H	PPG7	Yes	41	Programmable Pulse Generator 7
42	354 _H	PPG8	Yes	42	Programmable Pulse Generator 8
43	350 _H	PPG9	Yes	43	Programmable Pulse Generator 9
44	34C _H	PPG10	Yes	44	Programmable Pulse Generator 10
45	348 _H	PPG11	Yes	45	Programmable Pulse Generator 11
46	344 _H	PPG12	Yes	46	Programmable Pulse Generator 12
47	340 _H	PPG13	Yes	47	Programmable Pulse Generator 13
48	33C _H	PPG14	Yes	48	Programmable Pulse Generator 14
49	338 _H	PPG15	Yes	49	Programmable Pulse Generator 15
50	334 _H	PPG16	Yes	50	Programmable Pulse Generator 16
51	330 _H	PPG17	Yes	51	Programmable Pulse Generator 17
52	32C _H	PPG18	Yes	52	Programmable Pulse Generator 18
53	328 _H	PPG19	Yes	53	Programmable Pulse Generator 19
54	324 _H	RLT0	Yes	54	Reload Timer 0
55	320 _H	RLT1	Yes	55	Reload Timer 1
56	31C _H	RLT2	Yes	56	Reload Timer 2
57	318 _H	RLT3	Yes	57	Reload Timer 3
58	314 _H	PPGRLT	Yes	58	Reload Timer 6 - dedicated for PPG
59	310 _H	ICU0	Yes	59	Input Capture Unit 0
60	30C _H	ICU1	Yes	60	Input Capture Unit 1
61	308 _H				Reserved
62	304 _H				Reserved
63	300 _H	ICU4	Yes	63	Input Capture Unit 4
64	2FC _H	ICU5	Yes	64	Input Capture Unit 5
65	2F8 _H	ICU6	Yes	65	Input Capture Unit 6
66	2F4 _H	ICU7	Yes	66	Input Capture Unit 7

MB96350 Series

(T_A = -40°C to 125°C, V_{CC} = AV_{CC} = 3.0V to 5.5V, V_{SS} = AV_{SS} = 0V)

Parameter	Symbol	Condition (at T _A)	Value			Remarks	
			Typ	Max	Unit		
Power supply current in Sleep modes*	I _{CCSMAIN}	Main Sleep mode with CLKS1/2 = CLKP1/2 = 4MHz	+25°C	1.5	1.8	mA	
		(CLKPLL, CLKSC and CLKRC stopped)	+125°C	2	4.5		
	I _{CCSRCH}	RC Sleep mode with CLKS1/2 = CLKP1/2 = 2MHz	+25°C	0.8	1.3	mA	
		(CLKMC, CLKPLL and CLKSC stopped)	+125°C	1.4	4		
	I _{CCSRCL}	RC Sleep mode with CLKS1/2 = CLKP1/2 = 100kHz, SMCR:LPMSS = 0	+25°C	0.3	0.5	mA	MB96F356
			+125°C	0.8	3.4		
		(CLKMC, CLKPLL and CLKSC stopped. Voltage regulator in high power mode)	+25°C	0.09	0.2	mA	MB96F353/F355
			+125°C	0.59	3.1		
		RC Sleep mode with CLKS1/2 = CLKP1/2 = 100kHz, SMCR:LPMSS = 1	+25°C	0.06	0.15	mA	
			(CLKMC, CLKPLL and CLKSC stopped. Voltage regulator in low power mode)	+125°C	0.56		
	I _{CCSSUB}	Sub Sleep mode with CLKS1/2 = CLKP1/2 = 32kHz	+25°C	0.04	0.12	mA	
			(CLKMC, CLKPLL and CLKRC stopped)	+125°C	0.54		
Power supply current in Timer modes*	I _{CCTPLL}	PLL Timer mode with CLKMC = 4MHz, CLKPLL = 48MHz	+25°C	1.6	2	mA	
		(CLKRC and CLKSC stopped. Core voltage at 1.9V)	+125°C	2.1	4.8		

MB96350 Series

(T_A = -40°C to 125°C, V_{CC} = AV_{CC} = 3.0V to 5.5V, V_{SS} = AV_{SS} = 0V)

Parameter	Symbol	Condition (at T _A)		Value			Remarks
				Typ	Max	Unit	
Power supply current in Stop Mode	I _{CCH}	VR _{CR} :LPMB[2:0] = 110 _B (Core voltage at 1.8V)	+25°C	0.02	0.08	mA	
			+125°C	0.52	2.8		
		VR _{CR} :LPMB[2:0] = 000 _B (Core voltage at 1.2V)	+25°C	0.015	0.06	mA	
			+125°C	0.4	2.3		
Power supply current for active Low Voltage detector	I _{CCLVD}	Low voltage detector enabled (R _{CR} :LVDE = 1)	-	5	10	μA	MB96F353/F355 Must be added to all current above
			+25°C	90	140	μA	MB96F356 Must be added to all current above
			+125°C	100	150		
Power supply current for active Clock modulator	I _{CCCLOMO}	Clock modulator enabled (C _{MCR} :PDX = 1)	-	3	4.5	mA	Must be added to all current above
Flash Write/Erase current	I _{CCFLASH}	Current for one Flash module	-	15	40	mA	Must be added to all current above
Input capacitance	C _{IN}	-	-	5	15	pF	Other than C, AV _{CC} , AV _{SS} , AVR _H , AVR _L , V _{CC} , V _{SS}

* The power supply current is measured with a 4MHz external clock connected to the Main oscillator and a 32kHz external clock connected to the Sub oscillator. See chapter "Standby mode and voltage regulator control circuit" of the Hardware Manual for further details about voltage regulator control.

4. AC Characteristics

Source Clock timing

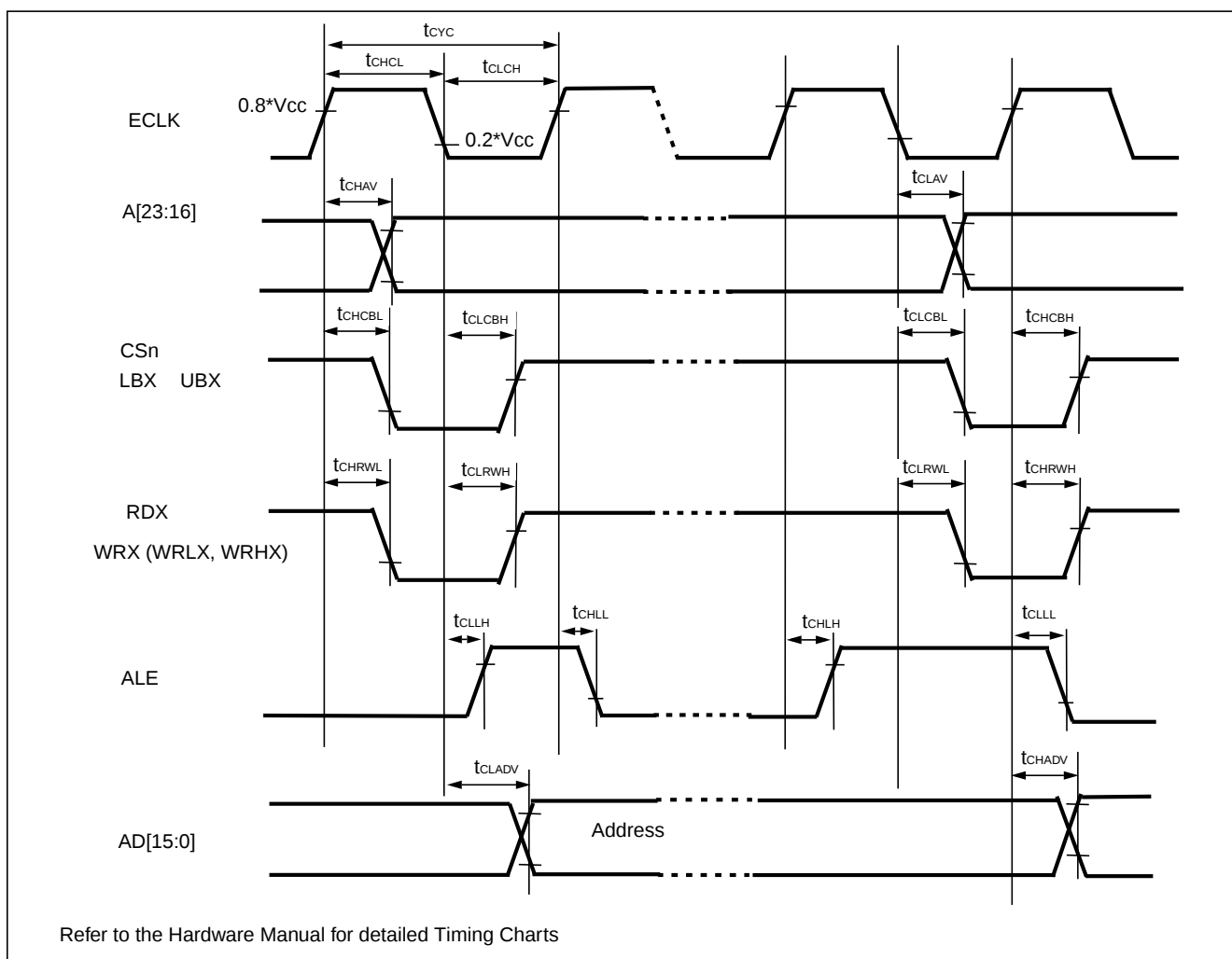
($T_A = -40^{\circ}\text{C}$ to 125°C , $V_{CC} = AV_{CC} = 3.0\text{V}$ to 5.5V , $V_{SS} = AV_{SS} = 0\text{V}$)

Parameter	Symbol	Pin	Value			Unit	Remarks
			Min	Typ	Max		
Clock frequency	f_C	X0, X1	3	-	16	MHz	When using a crystal oscillator, PLL off
			0	-	16	MHz	When using an opposite phase external clock, PLL off
			3.5	-	16	MHz	When using a crystal oscillator or opposite phase external clock, PLL on
Clock frequency	f_{FCI}	X0	0	-	56	MHz	When using a single phase external clock in "Fast Clock Input mode", PLL off
			3.5	-	56	MHz	When using a single phase external clock in "Fast Clock Input mode", PLL on
Clock frequency	f_{CL}	X0A, X1A	32	32.768	100	kHz	When using an oscillation circuit
			0	-	100	kHz	When using an opposite phase external clock
		X0A	0	-	50	kHz	When using a single phase external clock
Clock frequency	f_{CR}	-	50	100	200	kHz	When using slow frequency of RC oscillator
			1	2	4	MHz	When using fast frequency of RC oscillator
PLL Clock frequency	f_{CLKVCO}	-	64	-	200	MHz	Permitted VCO output frequency of PLL (CLKVCO)
PLL Phase Jitter	T_{PSKEW}	-	-	-	± 5	ns	For CLKMC (PLL input clock) $\geq 4\text{MHz}$
Input clock pulse width	P_{WH}, P_{WL}	X0,X1	8	-	-	ns	Duty ratio is about 30% to 70%
Input clock pulse width	P_{WHL}, P_{WLL}	X0A,X1A	5	-	-	μs	

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($T_A = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$, $V_{CC} = 3.0$ to 4.5V , $V_{SS} = 0.0\text{V}$, $I_{Odrive} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Condition	Value		Unit	Remarks
				Min	Max		
ECLK	t_{CYC}	ECLK	—	30	—	ns	
	t_{CHCL}			$t_{CYC}/2-8$	$t_{CYC}/2+8$		
	t_{CLCH}			$t_{CYC}/2-8$	$t_{CYC}/2+8$		
ECLK → UBX/ LBX / CSn time	t_{CHCBH}	CSn, UBX, LBX, ECLK	—	-25	25	ns	
	t_{CHCBL}			-25	25		
	t_{CLCBH}			-25	25		
	t_{CLCBL}			-25	25		
ECLK → ALE time	t_{CHLH}	ALE, ECLK	—	-15	15	ns	
	t_{CHLL}			-15	15		
	t_{CLLH}			-15	15		
	t_{CLLL}			-15	15		
ECLK → address valid time	t_{CHAV}	A[23:16], ECLK	—	-20	20	ns	
	t_{CLAV}			-20	20		
	t_{CLADV}	AD[15:0], ECLK	—	-20	20	ns	
	t_{CHADV}			-20	20		
ECLK → RDX /WRX time	t_{CHRWLH}	RDX, WRX, WRLX, WRHX, ECLK	—	-15	15	ns	
	t_{CHRWL}			-15	15		
	t_{CLRWH}			-15	15		
	t_{CLRWL}			-15	15		



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Ready Input Timing

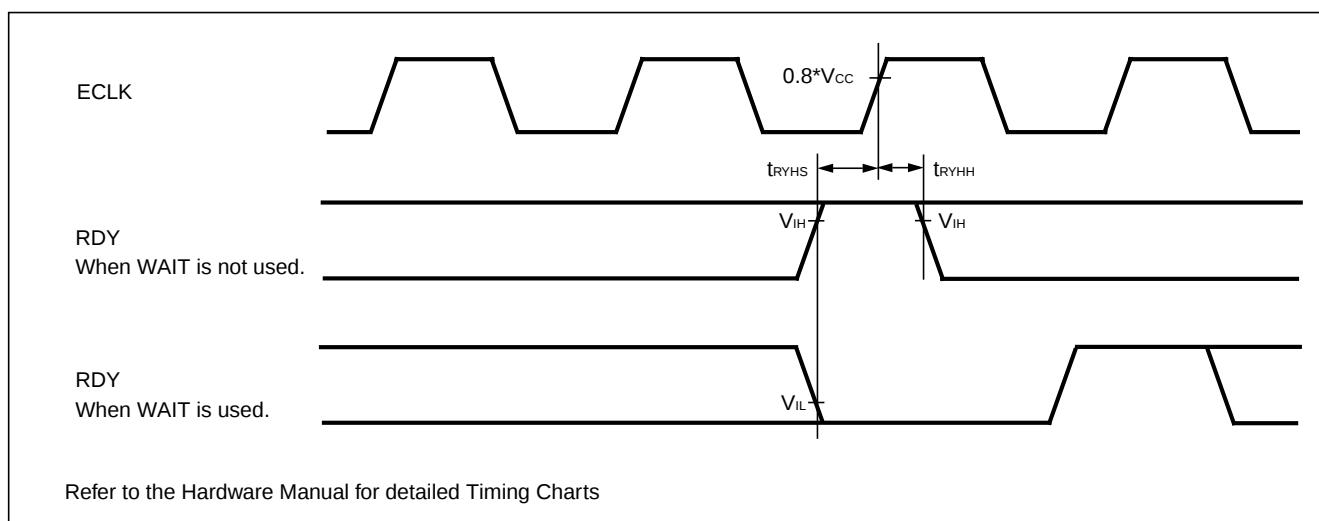
($T_A = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $I_{Odrive} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Test Condition	Rated Value		Units	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	35	—	ns	
RDY hold time	t_{RYHH}	RDY		0	—	ns	

($T_A = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$, $V_{CC} = 3.0$ to 4.5V , $V_{SS} = 0.0\text{ V}$, $I_{Odrive} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Test Condition	Rated Value		Units	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	45	—	ns	
RDY hold time	t_{RYHH}	RDY		0	—	ns	

Note : If the RDY setup time is insufficient, use the auto-ready function.



Hold Timing

($T_A = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$, $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = 0.0\text{ V}$, $I_{Odrive} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Condition	Value		Units	Remarks
				Min	Max		
Pin floating $\Rightarrow$ HAKX $\downarrow$ time	t_{XHAL}	HAKX	—	$t_{CYC} - 20$	$t_{CYC} + 20$	ns	
HAKX $\uparrow$ time $\Rightarrow$ Pin valid time	t_{HAHV}	HAKX		$t_{CYC} - 20$	$t_{CYC} + 20$	ns	

($T_A = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$, $V_{CC} = 3.0$ to 4.5V , $V_{SS} = 0.0\text{ V}$, $I_{Odrive} = 5\text{mA}$, $C_L = 50\text{pF}$)

Parameter	Symbol	Pin	Condition	Value		Units	Remarks
				Min	Max		
Pin floating $\Rightarrow$ HAKX $\downarrow$ time	t_{XHAL}	HAKX	—	$t_{CYC} - 25$	$t_{CYC} + 25$	ns	
HAKX $\uparrow$ time $\Rightarrow$ Pin valid time	t_{HAHV}	HAKX		$t_{CYC} - 25$	$t_{CYC} + 25$	ns	

MB96350 Series

I²C Timing

(T_A = -40°C to 125°C, V_{CC} = AV_{CC} = 3.0V to 5.5V, V_{SS} = AV_{SS} = 0V)

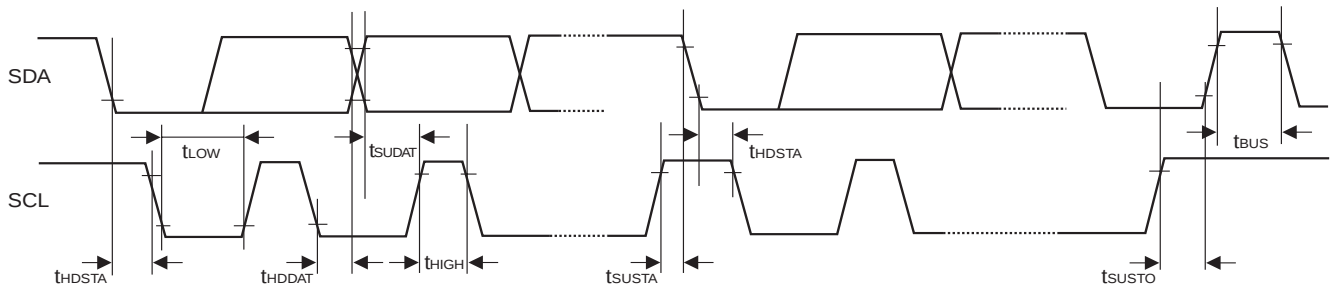
Parameter	Symbol	Condition	Standard-mode		Fast-mode*4		Unit
			Min	Max	Min	Max	
SCL clock frequency	f _{SCL}	R = 1.7 kΩ, C = 50 pF*1	0	100	0	400	kHz
Hold time (repeated) START condition SDA↓→SCL↓	t _{HDSTA}		4.0	—	0.6	—	μs
"L" width of the SCL clock	t _{LOW}		4.7	—	1.3	—	μs
"H" width of the SCL clock	t _{HIGH}		4.0	—	0.6	—	μs
Set-up time for a repeated START condition SCL↑→SDA↓	t _{SUSTA}		4.7	—	0.6	—	μs
Data hold time SCL↓→SDA↓↑	t _{HDDAT}		0	3.45*2	0	0.9*3	μs
Data set-up time SDA↓↑→SCL↑	t _{SUDAT}		250	—	100	—	ns
Set-up time for STOP condition SCL↑→SDA↑	t _{SUSTO}		4.0	—	0.6	—	μs
Bus free time between a STOP and START condition	t _{BUS}		4.7	—	1.3	—	μs

*1 : R,C : Pull-up resistor and load capacitor of the SCL and SDA lines.

*2 : The maximum t_{HDDAT} have only to be met if the device does not stretch the "L" width (t_{LOW}) of the SCL signal.

*3 : A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement t_{SUDAT} ≥ 250 ns must then be met.

*4 : For use at over 100 kHz, set the peripheral clock 1 to at least 6 MHz.



Definition of A/D Converter Terms

Resolution: Analog variation that is recognized by an A/D converter.

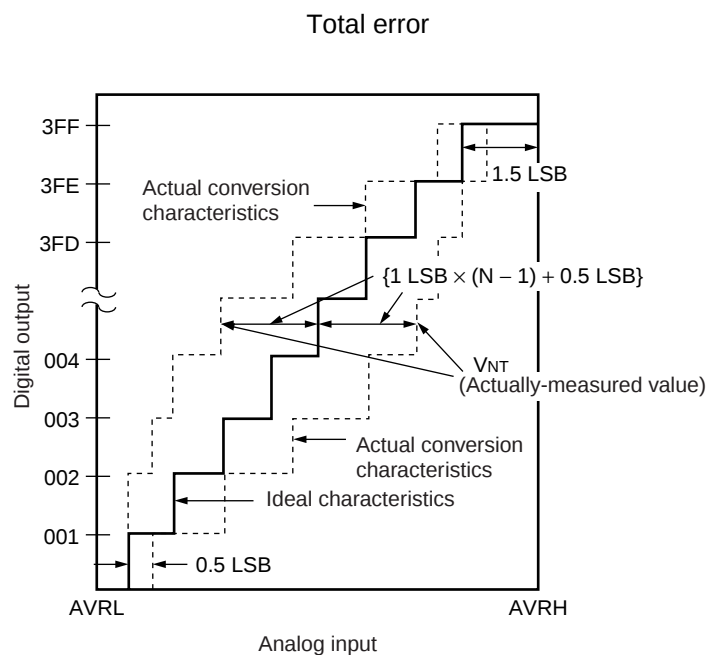
Total error: Difference between the actual value and the ideal value. The total error includes zero transition error, full-scale transition error and nonlinearity error.

Nonlinearity error: Deviation between a line across zero-transition line ("00 0000 0000" <--> "00 0000 0001") and full-scale transition line ("11 1111 1110" <--> "11 1111 1111") and actual conversion characteristics.

Differential nonlinearity error: Deviation of input voltage, which is required for changing output code by 1 LSB, from an ideal value.

Zero reading voltage: Input voltage which results in the minimum conversion value.

Full scale reading voltage: Input voltage which results in the maximum conversion value.



$$\text{Total error of digital output "N"} = \frac{V_{NT} - \{1 \text{ LSB} \times (N - 1) + 0.5 \text{ LSB}\}}{1 \text{ LSB}} \quad [\text{LSB}]$$

$$1 \text{ LSB} = (\text{Ideal value}) \frac{AVRH - AVRL}{1024} \quad [\text{V}]$$

N: A/D converter digital output value

$$V_{OT} (\text{Ideal value}) = AVRL + 0.5 \text{ LSB} \quad [\text{V}]$$

$$V_{FST} (\text{Ideal value}) = AVRH - 1.5 \text{ LSB} \quad [\text{V}]$$

V_{NT} : A voltage at which digital output transitions from (N - 1) to N.

Low Voltage Detector Operation

In the following figure, the occurrence of a low voltage condition is illustrated. For a detailed description of the reset and startup behavior, please refer to the corresponding hardware manual chapter.

